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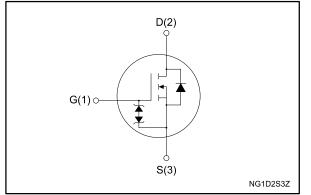
STW37N60DM2AG

Automotive-grade N-channel 600 V, 0.094 Ω typ., 28 A MDmesh[™] DM2 Power MOSFET in a TO-247 package

Datasheet - production data

TO-247

Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID	P _{TOT}
STW37N60DM2AG	600 V	0.110 Ω	28 A	210 W

- Designed for automotive applications and AEC-Q101 qualified
- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

Applications

• Switching applications

Description

This high voltage N-channel Power MOSFET is part of the MDmesh[™] DM2 fast recovery diode series. It offers very low recovery charge (Qrr) and time (trr) combined with low R_{DS(on)}, rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STW37N60DM2AG	37N60DM2	TO-247	Tube

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This is information on a product in full production.

Contents

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±25	V
L_	Drain current (continuous) at T _{case} = 25 °C	28	А
lD	Drain current (continuous) at T _{case} = 100 °C	17	A
IDM ⁽¹⁾	Drain current (pulsed)	112	А
P _{TOT}	Total dissipation at T _{case} = 25 °C	210	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	50	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	v/ns
T _{stg}	Storage temperature	55 to 150	°C
Tj	Operating junction temperature	-55 to 150	C

Notes:

 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ I_{SD} ≤ 28 A, di/dt=800 A/µs; V_{DS} peak < V_(BR)DSS,V_DD = 80% V_(BR)DSS.

⁽³⁾ $V_{DS} \le 480 \text{ V}.$

Table 3: Thermal data

Symbol	Parameter	Value	Unit	
R _{thj} -case	Thermal resistance junction-case	0.6	9 C A A/	
R _{thj-amb}	Thermal resistance junction-amb	50	°C/W	

Table 4: Avalanche characteristics

Symbol Parameter		Value	Unit
lar	Avalanche current, repetitive or not repetitive	6	А
Eas ⁽¹⁾	Single pulse avalanche energy	650	mJ

Notes:

 $^{(1)}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V$, $I_D = 1 mA$	600			V
Zana mata walta na dinain		$V_{GS} = 0 V, V_{DS} = 600 V$			10	
IDSS	Zero gate voltage drain current	V _{GS} = 0 V, V _{DS} = 600 V, T _{case} = 125 °C			100	μA
lgss	Gate-body leakage current	$V_{DS} = 0 V$, $V_{GS} = \pm 25 V$			±5	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 14 \text{ A}$		0.094	0.11	Ω

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	2400	-	
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	110	-	pF
Crss	Reverse transfer capacitance	V _{GS} = 0 V	-	2.8	-	μ.
Coss eq. ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 to 480 V, V_{GS} = 0 V	-	190	-	pF
R _G	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	4.3	-	Ω
Qg	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 28 \text{ A},$	-	54	-	
Q _{gs}	Gate-source charge	V _{GS} = 10 V (see Figure 15: "Test circuit for gate charge	-	14.6	-	nC
Q _{gd}	Gate-drain charge	behavior")	-	24.2	-	

Table 6: Dynamic

Notes:

 $^{(1)}$ Coss $_{\text{eq.}}$ is defined as a constant equivalent capacitance giving the same charging time as Coss when VDs increases from 0 to 80% VDss.

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 14 \text{ A}$	-	21.2	-	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Test circuit for	-	17	-	
t _{d(off)}	Turn-off delay time	resistive load switching times"	-	68	-	ns
tŕ	Fall time	and Figure 19: "Switching time waveform")	-	10.7	-	



STW37N60DM2AG

Electrical characteristics

Symbol	Parameter	ble 8: Source-drain diode Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		28	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		112	А
Vsd ⁽²⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 28 A	-		1.6	V
trr	Reverse recovery time	I _{SD} = 28 A, di/dt = 100 A/µs,	-	120		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 16: "Test circuit for inductive load	-	572		nC
I _{RRM}	Reverse recovery current	switching and diode recovery times")	-	10.2		А
trr	Reverse recovery time	I _{SD} = 28 A, di/dt = 100 A/µs,	-	215		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	1.89		μC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	17.7		A

Notes:

⁽¹⁾ Pulse width is limited by safe operating area.

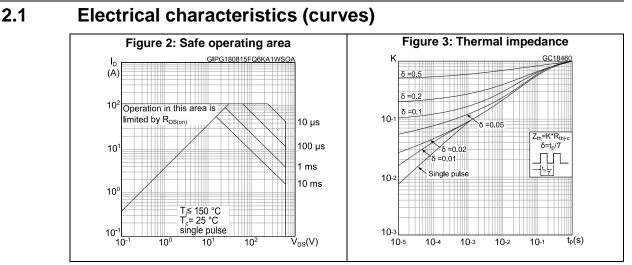
 $^{(2)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.

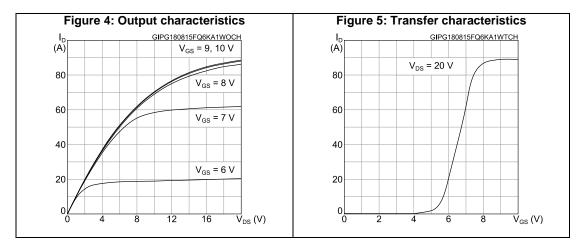
Table 9: Gate-source Zener diode

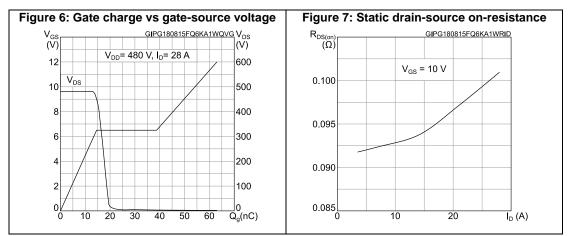
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _(BR) GSO	Gate-source breakdown voltage	$I_{GS} = \pm 250 \ \mu A, \ I_{D} = 0 \ A$	±30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.





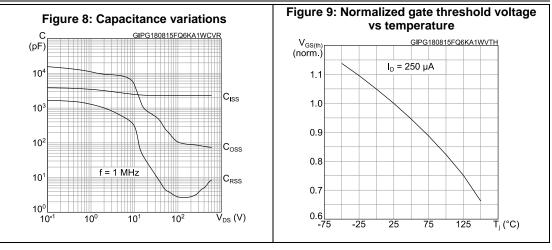


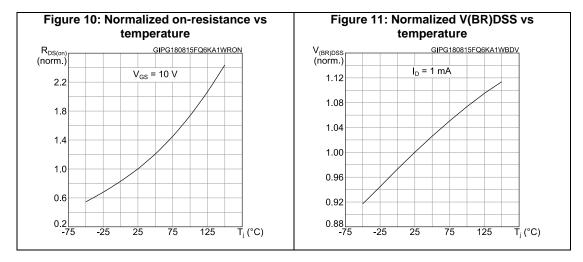


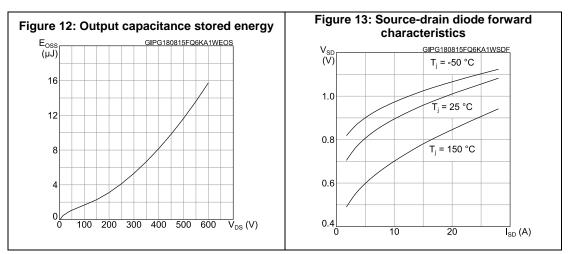
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Electrical characteristics



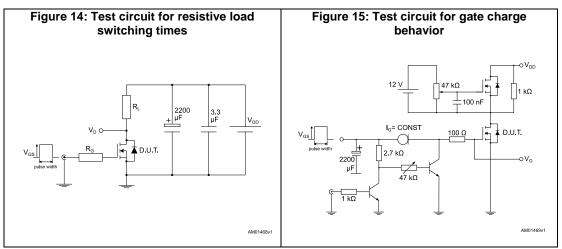


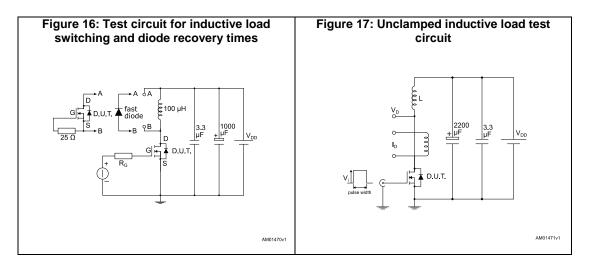


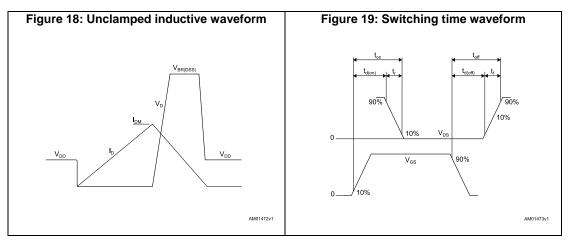


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3 Test circuits





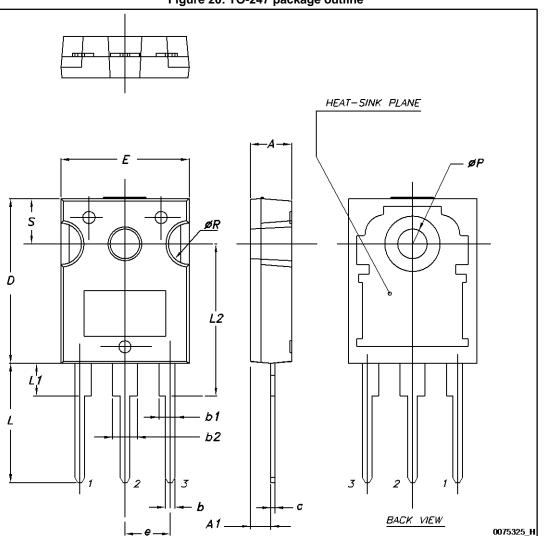


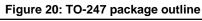


4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247 package information







Package information

STW37N60DM2AG

normation STW37N00DM2A0					
	Table 10: TO-247 pac	kage mechanical data			
Dim		mm.			
Dim.	Min.	Тур.	Max.		
A	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
E	15.45		15.75		
е	5.30	5.45	5.60		
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
ØP	3.55		3.65		
ØR	4.50		5.50		
S	5.30	5.50	5.70		

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5 Revision history

Table 11: Document revision history

Date	Revision	Changes
25-Aug-2015	1	Initial version



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